

Conference Diary

1980

Coatings & Films Conference	New Hampshire U.S.A.	11–15 August	Dr. A.M. Cruickshank Gordon Research Conferences, Pastore Chemical Labs, University of Rhode Island, Kingston, R.I. 02881, U.S.
Dielectric Solids	University of Kent, Canterbury, U.K.	8–11 Sept.	The Meetings Officer, I.O.P., 47 Belgrave Sq., London, SW1X 8QX, U.K.
Annual Conference on Electrical overstress/ Electrostatic Discharge Effects on Microelectronics and Other Electronic Components	San Diego, Cal., U.S.A.	9–11 Sept.	Mark Carpenter, Gould Inc., 18901 Euclid Ave., Cleveland, Ohio, 44117, U.S.
10th European Solid State Device Research Conf. 5th Symposium on Solid State Device Technology	York, England	15–19 Sept.	Meetings Office, I.O.P., 47 Belgrave Square, London, SW1X 8QX, U.K.
8th Int. Vacuum Congress 4th Int. Conf. on Solid Surfaces 3rd European Conf. on Surface Science	Cannes, France	22–26 Sept.	French Vacuum Society, 19 rue due Renard, F–75004, Paris, France.
Developments in Small Capacitors	London, U.K.	18th Sept.	Muriel A. Hunns, ERA, Cleeve Rd., Leatherhead, Surrey, U.K.
Summer School on Formation Processes in Thin Films	Fonyód, Hungary.	28th Sept – 4th Oct.	Mrs. E. Nagy, Roland Eötvös Physical Society, H–1368, Budapest, P.O.B. 240

International Microelectronics Symposium (sponsored by ISHM)	New York, U.S.A.	20–22 Oct.	George D. Lane, Electro Materials Corp. of America, 605 Center Ave., Mamoroneck, N.Y. 10543, U.S.A.
Electronica. Technical Conf., Microelectronics Congress and Trade Fair for Components and Assemblies	Munich, W. Germany	6–12 Nov.	Frau M. Brunner, Congress Office, P.O.B. 12 1009, D–8000, Munchen 12.
International Electron Device Meeting	Washington, D.C., U.S.A.	December	IEEE, 345 East 47 St., New York, N.Y. 10017, U.S.A.
1981 <i>Preliminary Announcements</i>			
1981 Reliability & Maintainability Symposium	Philadelphia, U.S.A.	27–29 Jan.	J.C. Sindt, Honeywell Inc., 1625 Zarthan Ave., St. Louis Park, Minn. 55416, U.S.
Europysics Conference on Oriented Polymers	Leeds, U.K.	7–10 April	Meetings Officer, I.O.P., 47 Belgrave Sq., London, U.K.
International Component Show	Paris, France	April	S.D.S.A., 20 rue Hamelin, 75116, Paris, France.
31st Electronic Component Conference	Atlanta, U.S.A.	11–13 May	IEEE, 345 E 47 St., New York, N.Y. 10017, U.S.
European Hybrid Microelectronics Conference	Avignon, France	20–22 May	Dr. B. Dreyfus-Alain, ISHM Conf. Secretariat, 11, rue Hamelin, 35783 Paris, France.
Ion & Plasma Assisted Techniques	Amsterdam, Holland	30th June – 2nd July	Secretariat, 26 Albany Street, Edinburgh, U.K.
5th International Thin Films Conference	Herzlia, Israel	21–25 Sept.	Dr Y. Shapiro, 122 Hayarkon St., P.O. Box 3054, Tel Aviv, Israel.

Hybrid Microelectronics Conf. (ISHM)	U.S.A.	Fall	Glen Dowler, ISHM, P.O. 3255, Montgomery, Alabama 36109, U.S.A.
Productronica	Munich, W. Germany	9–14 Nov.	Frau. M. Brunner, Congress Office, POB 12, 1009, D–8000, Munchen, 12.



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